

- [54] **METHOD OF FABRICATING
EMITTER/DETECTOR-IN-A-WELL FOR
THE INTEGRATION OF ELECTRONIC AND
OPTOELECTRONIC COMPONENTS**
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Related U.S. Application Data

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- [52] **U.S. Cl.** 29/569 L; 29/572;
29/576 E; 29/580; 148/171; 148/175;
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357/30
- [58] **Field of Search** 29/569 L, 572, 580,
29/576 E; 148/171, 175, DIG. 50, DIG. 72;
357/16, 17, 30

- [56] **References Cited**
U.S. PATENT DOCUMENTS
3,978,428 8/1976 Burnham et al. 357/16

OTHER PUBLICATIONS
Tsang et al., *Applied Physics Letters* vol. 30, pp. 293-296,
1977.

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[57] **ABSTRACT**
Integration of optoelectronic component and electronic components in a planar surface of a semi-insulating substrate such as gallium arsenide. A depression is etched into the planar surface to contain the transverse junction stripe laser structure which is grown by epitaxial layers. In the resulting structure the surface of the epitaxial layers forms a portion of the planar surface, thus placing the electrical and optical elements on or at the planar surface to facilitate fabrication and testing.

12 Claims, 5 Drawing Figures

